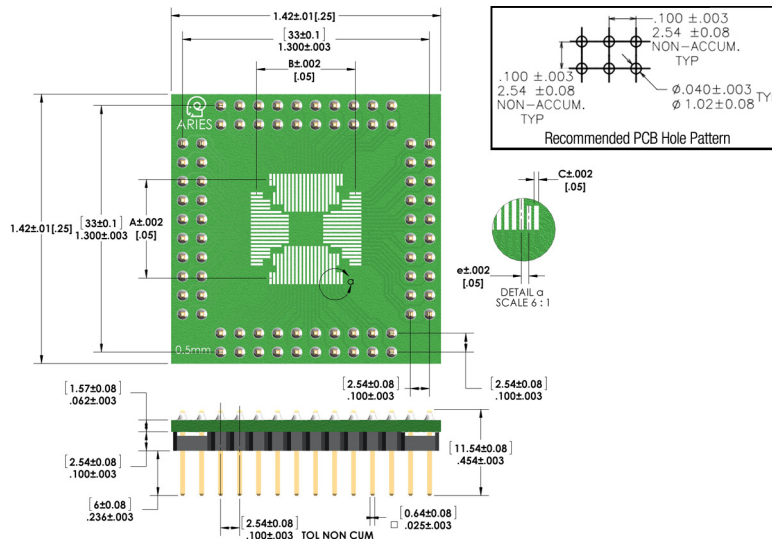




- Mates common QFP packages to standard breadboard and breakout boards for rapid and easy prototyping
- Panelized adapters available upon request

- BOARD MATERIAL: 0.062 [1.58] thick FR-4, UL 94V-0 with 1/2-oz. Cu traces
- PIN INSULATOR: Polyester, UL 94V-0
- PINS: Brass 360 1/2-hard per UNS C36000 ASTM-B16-00
- PIN PLATING: Au Flash
- OPERATING TEMPERATURE: -55°C to +125°C



• ALL DIMENSIONS: INCHES [MILLIMETERS] • ALL TOLERANCES: ± 0.005 [0.13] UNLESS OTHERWISE SPECIFIED • CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS

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